DIPLOMA - VIEP - ELECTRONICS & COMMUNICATION ENGINEERING - III SEM (DECVI) / ADVANCED LEVEL CERTIFICATE COURSE IN ELECTRONICS COMMUNICATION ENGINEERING (ACECVI)

Term-End Examination

December, 2013

BIEL-026: PCB Testing & Designing

Time: 2 hours				Maximum Marks: 70	
Note	•		empt any five question estion No. 1 is compul		
1.	Cho (a)	Three P.C.: person (i) (ii) (iii) (iv) The in P.C.I. pape (i) (ii) (iii)	rrect answer. re etching fluids in B's are ferrite chlorulphate and ammonium sulphate chromic acid chlorine Nitrate persulphate most commonly used B's are a phenolic resier or an epoxide resin reinforglass cloth. edge resin epidemy resin reinforglass cloth.	base materials for in reinforced with	
		(1V)	None of the above.		

(c)	Hand-soldering should be done with a soldering.			
	(i)	Light controlled		
	(ii)	temperature controlled		
	(iii)	Weight controlled		
	(iv)	None of the above		
(d)	Matlab stands for :			
	(i)	Matrix Laboratory		
	(ii)	Math Laboratory		
	(iii)	Mining Laboratory		
	(iv)	None of the above		
(e)	Boards for mounting integerated circuits would normally made from :			
	(i)	FR ₄ or G ₁₀ material		
	(ii)	FR ₅ or G ₁₁ material		
	(iii)	both (i) and (ii)		
	(iv)	None of the above		
(f)	The	final stage of board manufacture is the of the edges.		
	(i)	culting		
	(ii)	trimming		
	(iii)	splitting		
	(iv)	sharpening		
(g)	Writ	e true or false.		
		's can be soldered to plain boards out the ends of the leads being bent.		

2. Mention different types of P.C.B's and explain any 14 one in detail. 3. Discuss briefly "Mannual artwork" used in P.C.B 14 design. 4. Write down the steps involved in PCB fabrication. 14 (a) What are the precautions that should be 5. 7 taken while soldering P.C.B circuits? Define soldering. Mention different types of 7 (b) soldering. 6. Explain how MATLAB can be used for (a) 7 simulating the P.C.B circuit. Discuss simulation steps of a circuit by using (b) 7 P-spice. 7. Write short notes on any four of the following: Flexible P.C.B material (a) 4x3.5=14(b) ART work Common defects on wave soldering (c) (d) CAD Solderability (e) (f) Bridging